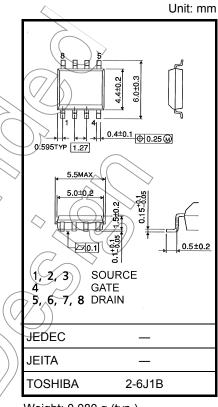
TOSHIBA Field Effect Transistor Silicon P Channel MOS Type (U-MOSIII)

TPC8109

Lithium Ion Battery Applications Notebook PC Applications Portable Equipment Applications

- Small footprint due to small and thin package
- Low drain-source ON resistance: $RDS(ON) = 14 \text{ m}\Omega \text{ (typ.)}$
- High forward transfer admittance: $|Y_{fs}| = 19 S$ (typ.)
- Low leakage current: $IDSS = -10 \mu A (max) (VDS = -30 V)$
- Enhancement mode: $V_{th} = -0.8 \text{ to } -2.0 \text{ V } (V_{DS} = -10 \text{ V}, I_D = -1 \text{ mA})$

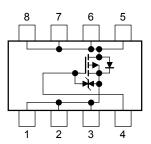


Weight: 0.080 g (typ.)

Absolute Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit	
Drain-source voltage		V _{DSS} <	-30	N	
Drain-gate voltage ($R_{GS} = 20 \text{ k}\Omega$)		V _{DGR}	30	< V	
Gate-source voltage			V _{GS})) ±20	V /
Drain current	DC	(Note 1)		-10	A
	Pulse	(Note 1)	((IDP))	-40	//^
Drain power dissipation (t = 10 s) (Note 2a)			PD	1.9	\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\
Drain power dissipation $(t = 10 \text{ s})$ (Note 2b)			PD	1.0	W
Single pulse avalanche energy (Note 3)			EAS	130	mJ
Avalanche current			I _{AR}	- 10	Α
Repetitive avalanche energy (Note 2a) (Note 4)		EAR	0.19	mJ	
Channel temperature		Tch	150	°C	
Storage temperature range			Tstg	-55 to 150	°C

Circuit Configuration



Note: (Note 1), (Note 2), (Note 3) and (Note 4): See the next page.

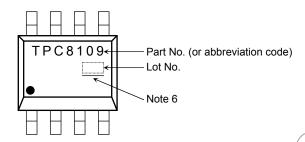
Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

This transistor is an electrostatic-sensitive device. Please handle with caution.

Thermal Characteristics

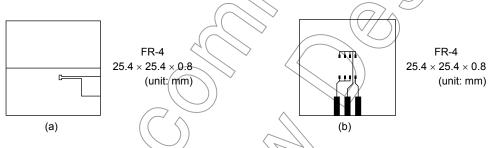
Characteristics	Symbol	Max	Unit	
Thermal resistance, channel to ambient $(t=10\;s) \eqno(Note\;2a)$	R _{th (ch-a)}	65.8	°C/W	
Thermal resistance, channel to ambient $(t = 10 \text{ s})$ (Note 2b)	R _{th (ch-a)}	125	°C/W	

Marking (Note 5)



Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: (a) Device mounted on a glass-epoxy board (b) Device mounted on a glass-epoxy board (b)



Note 3: $V_{DD} = -24 \text{ V}$, $T_{ch} = 25 \%$ (initial), L = 1.0 mH, $R_G = 25 \Omega$, $I_{AR} = -10 \text{ A}$

Note 4: Repetitive rating; pulse width limited by maximum channel temperature

Note 5: • on the lower left of the marking indicates Pin

Weekly code: (Three digits)
Week of manufacture
(0) for first week of year, continuing up to 52 or 53)
Year of manufacture
(The last digit of the calendar year)

Note 6: A line under a Lot No. identifies the indication of product Labels.

Not underlined: [[Pb]]//NCLUDES > MCV

Underlined: [[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product. The RoHS is the Directive 2002/95/EC of the European Parliament and of the Council of 27 January 2003 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.

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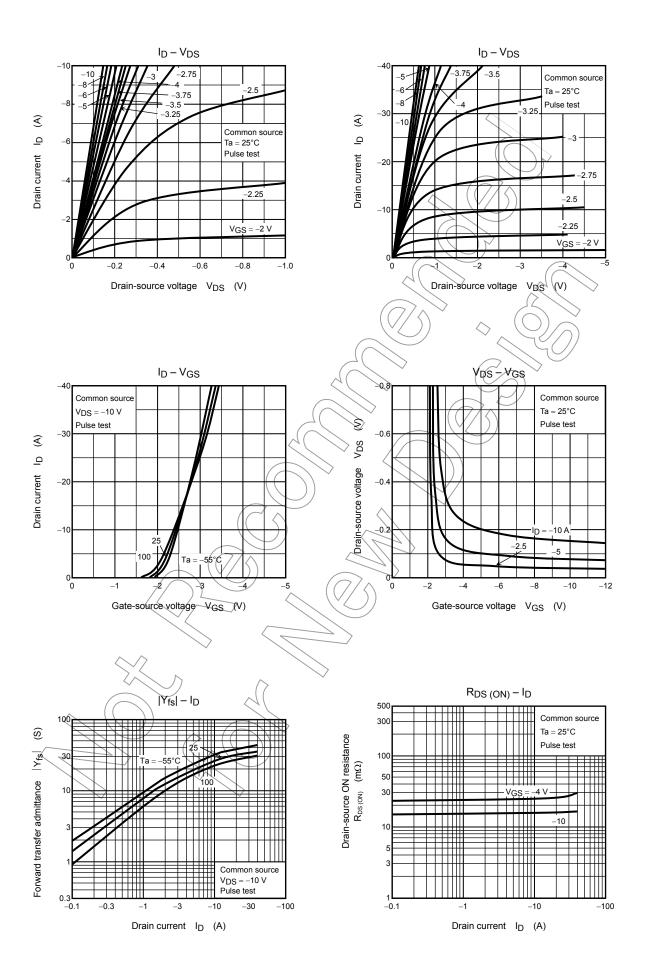
Electrical Characteristics (Ta = 25°C)

Cha	aracteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cur	rent	I _{GSS}	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0 \text{ V}$	_	_	±10	μΑ
Drain cut-OFF cu	ırrent	I _{DSS}	$V_{DS} = -30 \text{ V}, V_{GS} = 0 \text{ V}$	_	_	-10	μА
Drain-source breakdown voltage		V (BR) DSS	$I_D = -10 \text{ mA}, V_{GS} = 0 \text{ V}$	-30	_	_	V
		V (BR) DSX	$I_D = -10 \text{ mA}, V_{GS} = 20 \text{ V}$	15	_	_	
Gate threshold voltage		V_{th}	$V_{DS} = -10 \text{ V}, I_D = -1 \text{ mA}$	0.8) / _	-2.0	V
Drain-source ON resistance		R _{DS (ON)}	$V_{GS} = -4 \text{ V}, I_D = -5 \text{ A}$) 	24	30	- mΩ
			$V_{GS} = -10 \text{ V}, I_D = -5 \text{ A}$	\rightarrow	14	20	
Forward transfer admittance		Y _{fs}	$V_{DS} = -10 \text{ V}, I_D = -5 \text{ A}$	9	19	_	S
Input capacitance		C _{iss}		_	2260	_	
Reverse transfer capacitance		C _{rss}	$V_{DS} = -10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	_	290	_	pF
Output capacitance		Coss			350	7	
Switching time Fall tim	Rise time	t _r	0 V 7 V Jp ≠ -5 A	-(5	> _	
	Turn-ON time	t _{on}	VGS OVOUT		13	_	20
	Fall time	t _f	4 m m 4 m 0 m 1 m 1 m 1 m 1 m 1 m 1 m 1 m 1 m 1	(\mathcal{T})	34	_	ns
	Turn-OFF time	t _{off}	V _{DD} ≃ 15V Duty ≤ 1%, t _w = 10 µs) —	143	_	
Total gate charge (gate-source plus		Qg	$V_{DD} \simeq -24 \text{ V}, V_{GS} = -10 \text{ V},$	_	45	_	
Gate-source charge 1		Q _{gs1}	$I_D = -10 \text{ A}$	_	6.5	_	nC
Gate-drain ("miller") charge		Qgd		_	10	_	

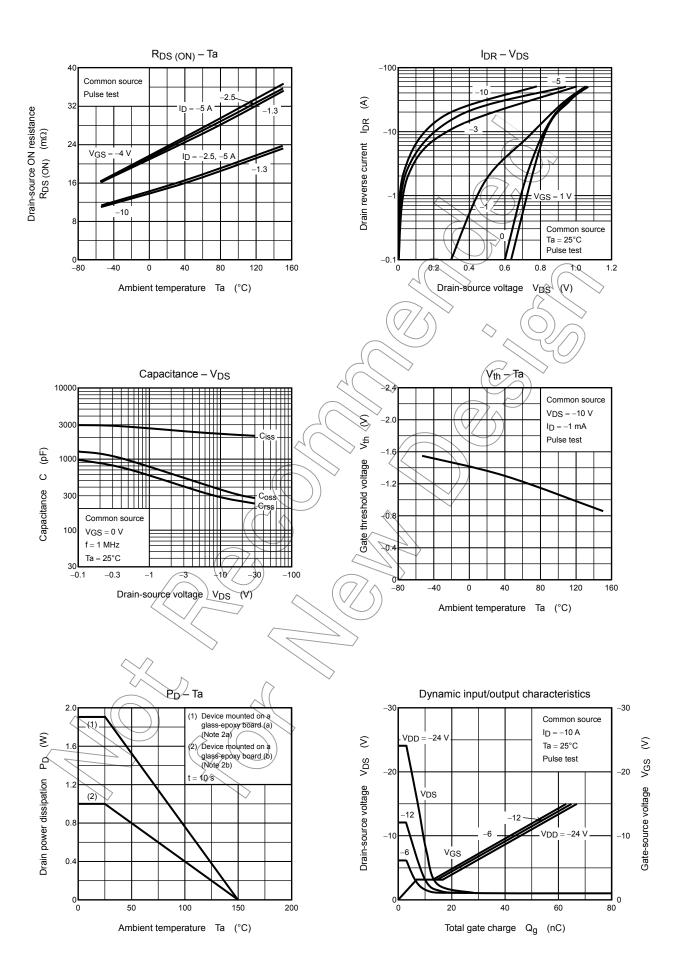
Source-Drain Ratings and Characteristics (Ta = 25°C)

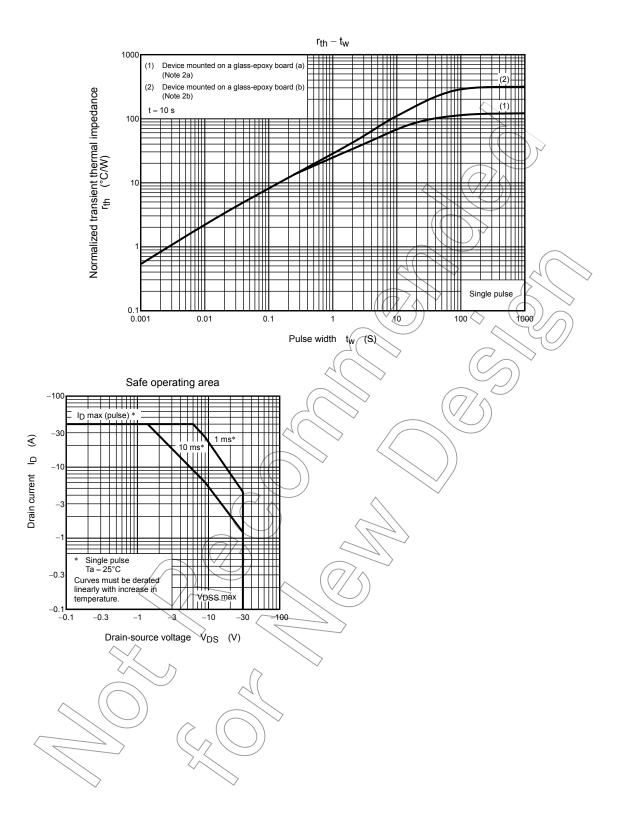
Characteristics	Symbol	Min	Тур.	Max	Unit
Drain reverse current Pulse (Note-1)	I _{DRP} —	_	_	-40	Α
Forward voltage (diode)	V _{DSE} I _{DR} = 11 A, V _{GS} = 0 V	_	_	1.2	V





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